

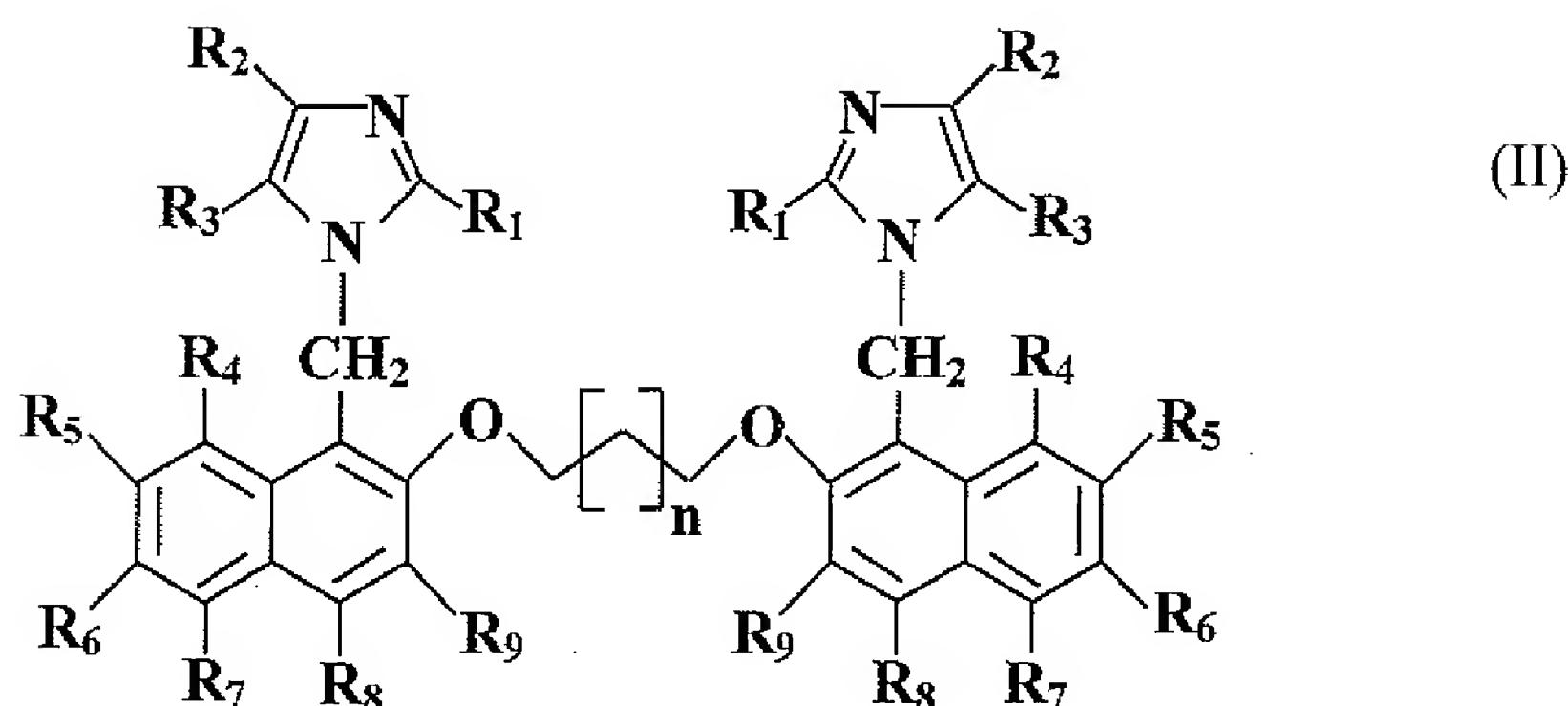
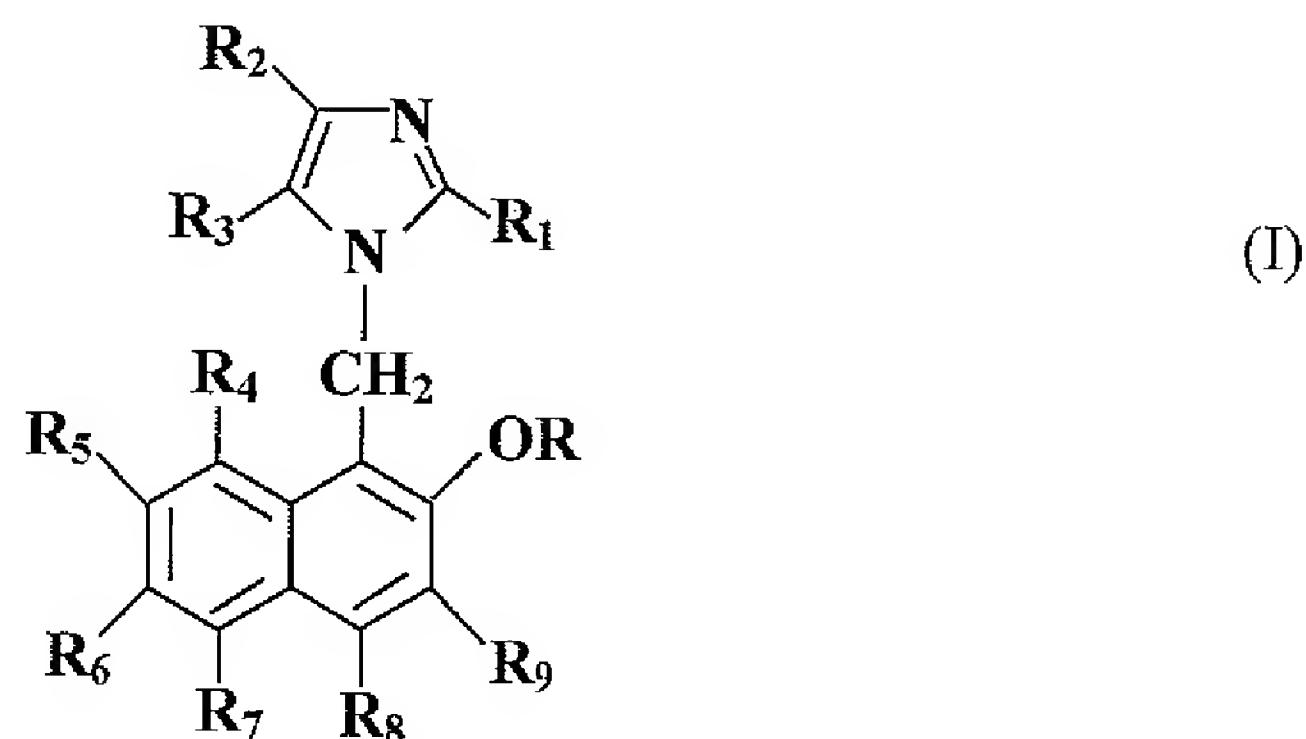
Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1-12 (cancelled).

Claim 13 (currently amended). A compound of general formula (I) or (II):



where

R₁, R₂, and R₃ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups, -CN, Hal,

OH, or C₁₋₁₀ alkoxy; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl; C₃₋₁₂ alkynyl; or aromatic or aliphatic C₃₋₁₂ acyl; R₄, R₅, R₆, R₇, R₈ and R₉ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₇ alkenyl; C₃₋₁₂ alkynyl; C₁₋₁₂ alkoxy or OH; for formula (I) R is C₁₋₁₂ alkyl or C₃₋₁₂ alkenyl; [; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl; or C₃₋₁₂ alkynyl;]] and for formula (II) n = 2-12.

Claim 14 (currently amended). A compound according to claim Claim 13, where R₁, R₂ and R₃ each independently of one another are H; C₁₋₁₇ alkyl; phenyl; or C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups.

Claim 15 (currently amended). A compound according to claim Claim 14, where R₂ and R₃ each H; and R₁ is C₁₋₁₇ alkyl; phenyl; or C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups.

Claim 16 (currently amended). A compound according to claim Claim 13, where for formula (I) R is C_{1-12} -alkyl or C_{3-12} -alkenyl; and for formula (II) n = 6 - 12.

Claim 17 (previously presented). A compound according to claim Claim 13, where R_4 , R_5 , R_6 , R_7 , R_8 and R_9 are H.

Claim 18 (currently amended). A compound according to claim Claim 13, where R₁ is methyl:

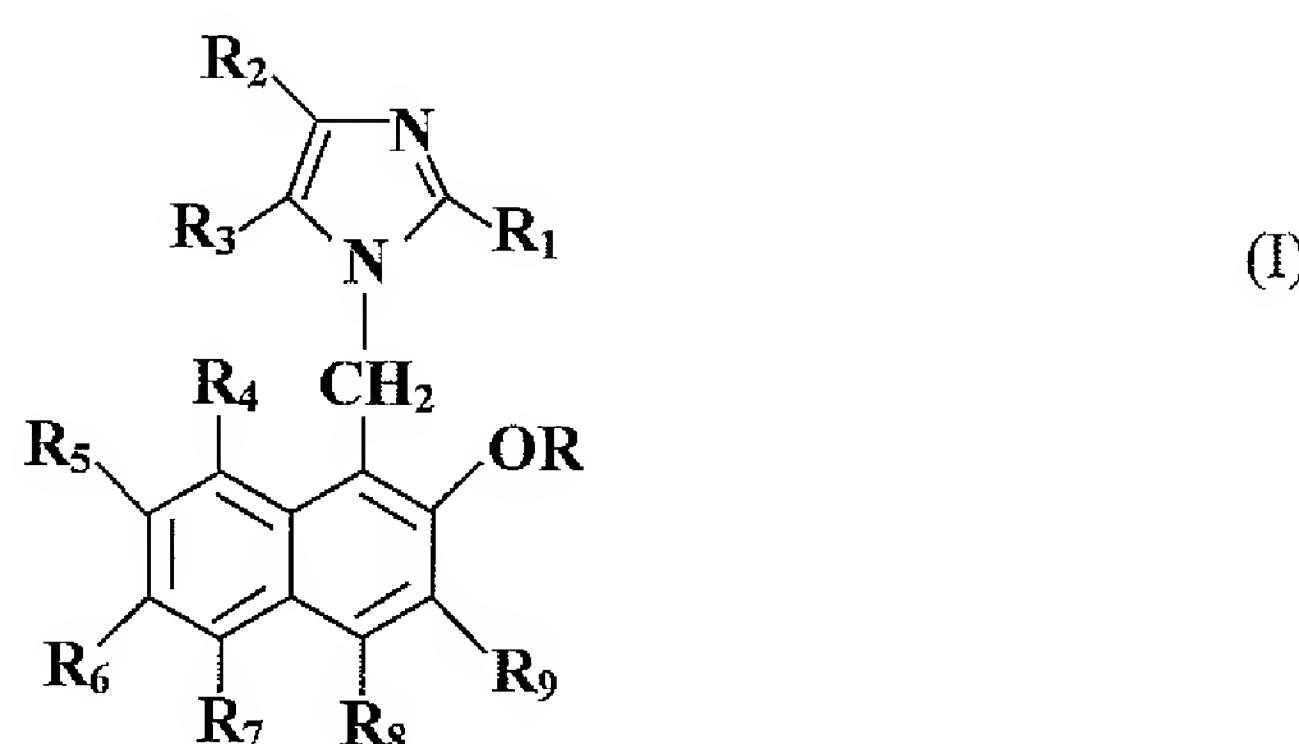
R₂, R₃, R₄, R₅, R₆, R₇, R₈ and R₉ are H;

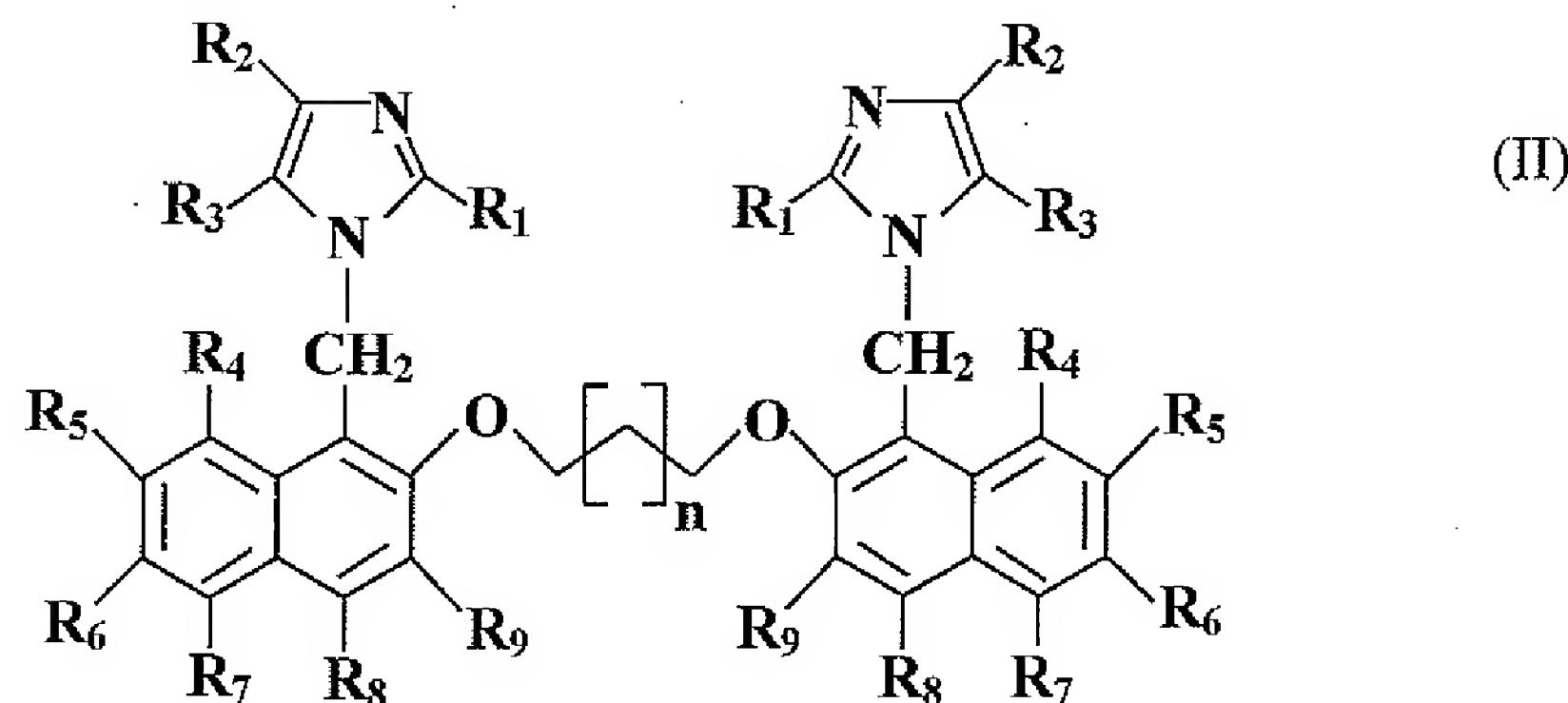
R is n-butyl, n-nonyl, n-dodecyl, or allyl; and

$$n = 8.$$

Claim 19 (previously presented). A curable composition comprising:

- a) an epoxy resin whose epoxide content is from 0.1 to 11 epoxide equivalents/kg;
- b) from 1 to 10 parts by weight, based on the total weight of the curable composition, of a compound of formula (I) or (II):





where

R₁, R₂, and R₃ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups, -CN, Hal, OH, or C₁₋₁₀ alkoxy; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl; C₃₋₁₂ alkynyl; or aromatic or aliphatic C₃₋₁₂ acyl; R₄, R₅, R₆, R₇, R₈ and R₉ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₇ alkenyl; C₃₋₁₂ alkynyl; C₁₋₁₂ alkoxy or OH; for formula (I) R is C₁₋₁₂ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl or C₃₋₁₂ alkynyl; and for formula (II) n = 2-12;

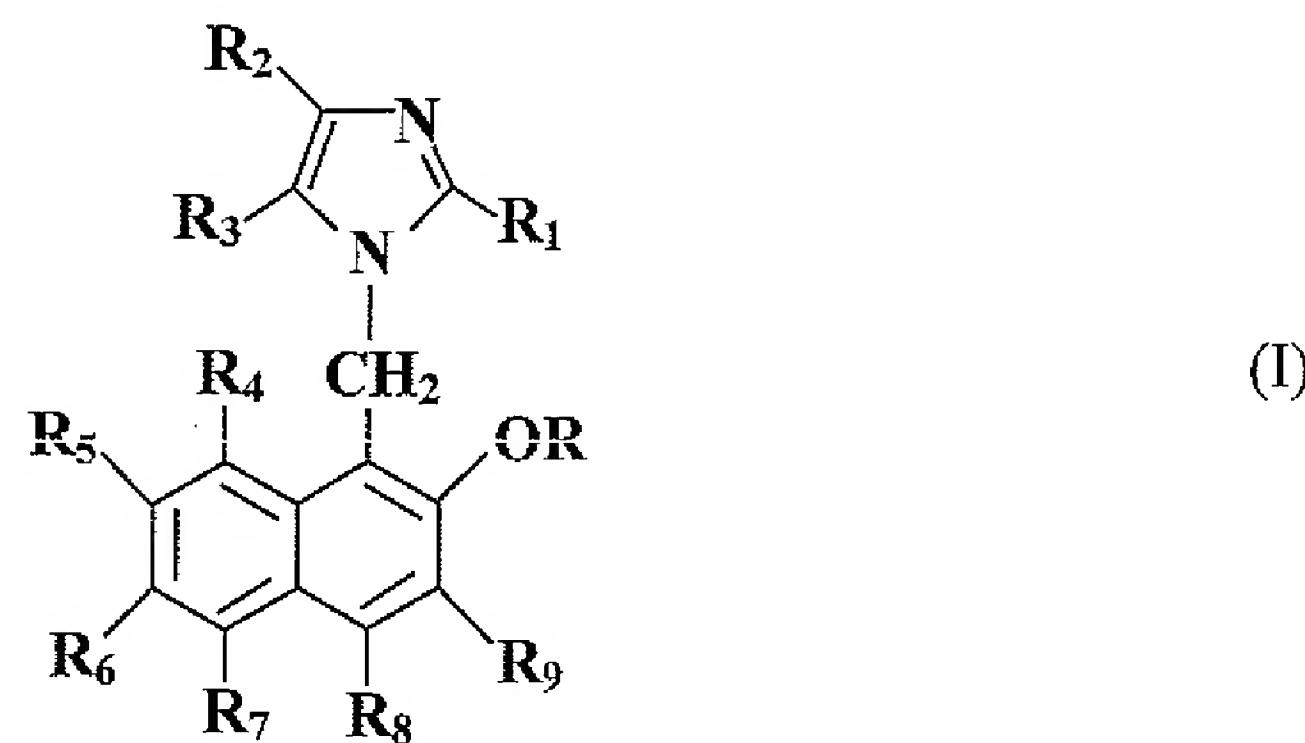
- c) a curing agent for the epoxy resin having from 0.5 to 1.5 functional groups per epoxide group; and optionally
- d) one or more additives.

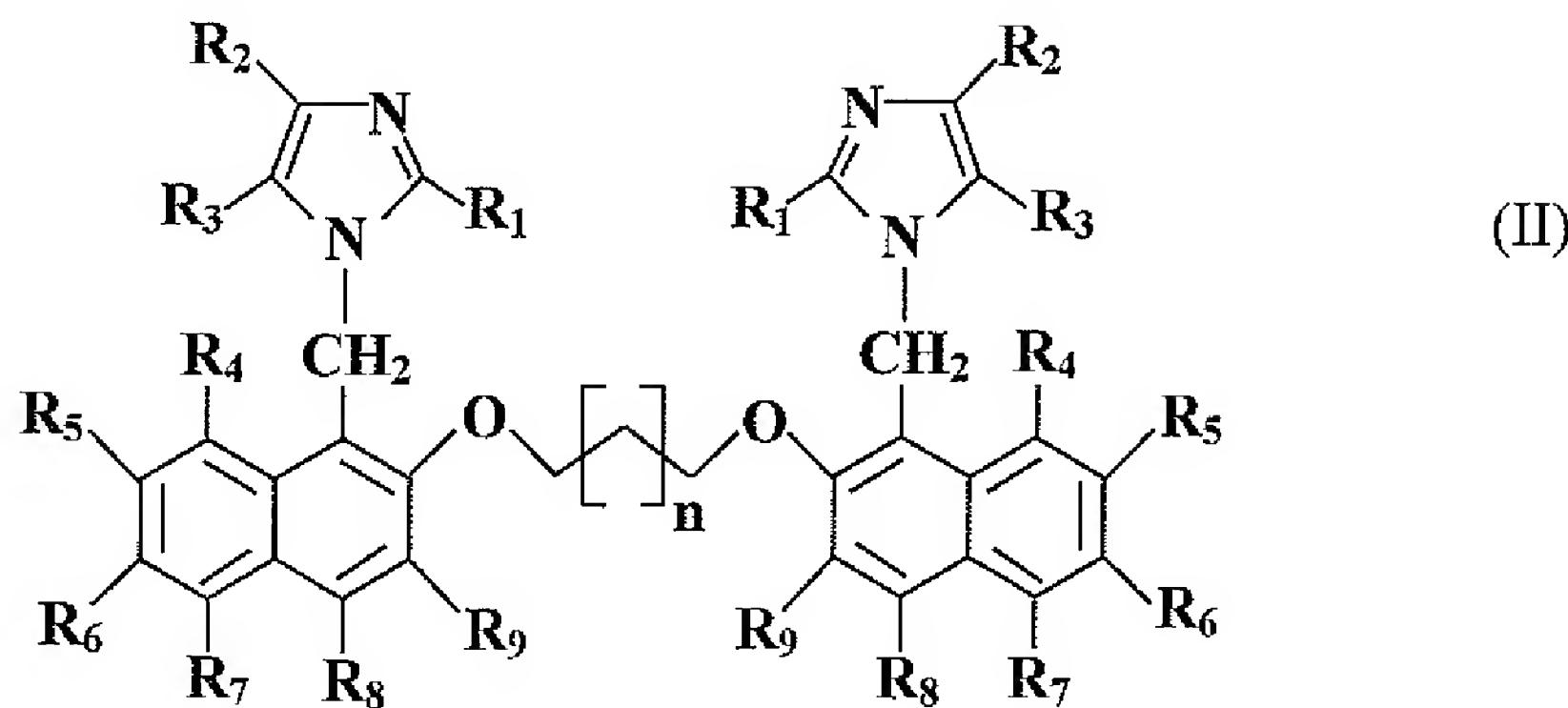
Claim 20 (currently amended). A curable composition according to claim Claim 19, wherein the curing agent is an amine or polyamine.

Claim 21 (currently amended). A curable composition according to claim Claim 20, wherein the curing agent is a polyoxypiperylenediamine.

Claim 22 (currently amended). A curable composition according to claim Claim 19, wherein the epoxy resin is a glycidyl ether, glycidyl ester, N-glycidyl or N,O-glycidyl derivative of an aromatic or heterocyclic compound, or a cycloaliphatic glycidyl compound.

Claim 23 (previously presented). A method for making a curable composition comprising adding to an epoxy resin a curing agent and a compound of formula (I) or (II):





where R₁, R₂, and R₃ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups, -CN, Hal, OH, or C₁₋₁₀ alkoxy; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl; C₃₋₁₂ alkynyl; or aromatic or aliphatic C₃₋₁₂ acyl;

R₄, R₅, R₆, R₇, R₈ and R₉ each independently of one another are H; C₁₋₁₇ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₇ alkenyl; C₃₋₁₂ alkynyl; C₁₋₁₂ alkoxy or OH;

for formula (I) R is C₁₋₁₂ alkyl; C₃₋₁₂ cycloalkyl, optionally substituted by C₁₋₄ alkyl groups; C₄₋₂₀ cycloalkyl-alkyl, optionally substituted by C₁₋₄ alkyl groups; C₆₋₁₀ aryl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₇₋₁₅ phenylalkyl, optionally substituted by 1-3 C₁₋₄ alkyl groups; C₃₋₁₂ alkenyl or C₃₋₁₂ alkynyl;

and for formula (II) n = 2-12.

Claim 24 (previously presented). The method of claim 23 wherein the compound of formula (I) or (II) is dissolved beforehand in the curing agent at a temperature between 60° - 80° C.

Claim 25 (previously presented). A prepreg comprising a curable composition according to claim Claim 19.